



PD3S120L

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI323

Features

- Guard Ring Die Construction for Transient Protection
- High Surge Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Ultra-Small Surface Mount Package
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI[®]323
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- · Polarity: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208³
- Weight: 0.006 grams (Approximate)



Top View



Bottom View

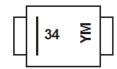
Ordering Information (Note 4)

Part Number	Case	Packaging
PD3S120L-7	PowerDI323	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



34 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 2 = Feb)

Date Code Key

Year	2004	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024
Code	R	В	С	D	Е	F	G	Η	_	7	K	L

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	V
RMS Reverse Voltage	V _{R(RMS)}	14	V
Average Forward Current (See Figure 6)	I _{F(AV)}	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	33	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	R ₀ JS	_	6	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	170	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	144	_	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to	+125	°C

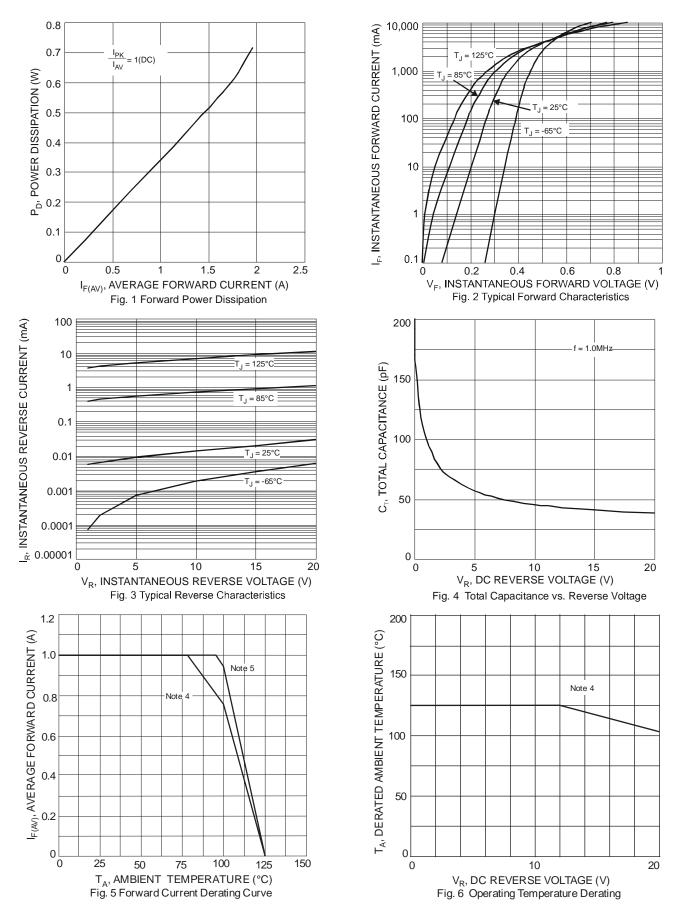
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	20		_	V	$I_R = 100\mu A$
		_	0.27	0.31	V	$I_F = 0.1A, T_A = +25$ °C
Forward Voltage	\/_	_	0.34	0.38		$I_F = 0.7A, T_A = +25^{\circ}C$
Forward Vollage	VF	_	0.36	0.42		$I_F = 1.0A, T_A = +25^{\circ}C$
		_	0.27	0.30		I _F = 1.0A, T _A = +125°C
			10	50	μA	$V_R = 5V, T_A = +25^{\circ}C$
Leakage Current (Note 7)			13	60	μA	$V_R = 10V, T_A = +25^{\circ}C$
Leakage Current (Note 1)	I _R	_	30	160	μA	$V_R = 20V, T_A = +25^{\circ}C$
			11	30	mA	$V_R = 20V, T_A = +125$ °C
Total Capacitance	Ст	_	46	_	pF	$V_R = 10V, f = 1.0MHz$

Notes:

- 5. FR-4 PCB, 2 oz. copper, minimum recommended pad layout per https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 6. Polymide PCB, 2 oz. copper, minimum recommended pad layout per https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 7. Short duration pulse test to minimize self-heating effect.



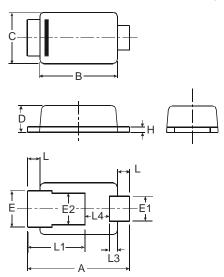




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI323

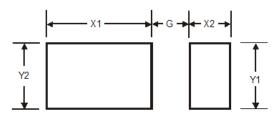


PowerDI323							
Dim	Min	Max	Тур				
Α	2.40	2.60	2.50				
В	1.85	1.95	1.90				
С	1.20	1.30	1.25				
D	0.60	0.70	0.65				
Е	0.78	0.98	0.88				
E1	0.50	0.70	0.60				
E2	0.60	1.00	0.80				
Н	0.08	0.18	0.13				
L	0.20	0.40	0.30				
L1	-	-	1.40				
L3	-	-	0.20				
L4	0.40	0.80	0.60				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI323



Dimensions	Value (in mm)
G	0.5
X1	2.0
X2	0.8
Y1	0.8
Y2	1.1



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